

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Masaru SHIRAI et al. Group Art Unit : 1735

Appl. No. : 10/598,142 (U.S. National Examiner : Nicholas D'ANIELLO
Stage of PCT/JP2005/005909)

I.A. Filed : March 17, 2005 Confirmation No. : 1550

For : HEATER, REFLOW APPARATUS, AND SOLDER BUMP FORMING
METHOD AND APPARATUS

RESPONSE UNDER 37 CFR § 1.116

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop AF
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Alexandria VA 22314

In response to the Official Action dated March 14, 2011, setting a shortened three-month statutory period for response to expire on June 14, 2011, the period for reply being extended to expire on July 14, 2011, by the accompanying one month Request for Extension of Time, Applicants respectfully request reconsideration and withdrawal of the outstanding rejections in view of the herein-contained amendments and remarks. However, if any extension of time is necessary, this is an express request for any necessary extension of time and authorization to charge any required extension of time fee or any other fees which may be required to preserve the pendency of the present application to Deposit Account No. 19-0089.

Amendments to the Claims begin on page 2 of this document.
Remarks begin on page 5 of this document.